

NXP S32G2 SMARC SoM

Product Brief







Tessolve introduces a SMARC 2.1 SoM (System-on-Module) based on the NXP S32G2 CPU a high-performance vehicle network processor which integrates Quad Arm® Cortex®-A53 cores operating at 1 GHz and Triple Arm Cortex-M7 dual-core lockstep cores operating at 400 MHz. NXP S32G274A chipset supports ASIL D system designs.

Tessolve leverages its vast experience of product development in automotive and industrial domains all the way from conceptualization to manufacturing to develop S32G2 based SOM and telematic gateway application board and solutions.

The SoM supports 4GB of LPDDR4, 32GB eMMC and 64MB QSPI memory and high-speed IO interfaces PCIe, USB and Gigabit Ethernet. The I/O voltage level is 3.3V

The Tessolve S32G2 SoM is targeted for Industrial and Automotive applications demanding real-time, high-performance processing and ASIL D safety chipset ASIL D safety chipset.

S32G2 Series of processors support ISO 26262 ASIL D safety and offers hardware security, high-performance and are targeted for next generation application processing and networking.

The Tessolve SoM comes with a complete software suite including Device Drivers, BSP and support for Linux v5.4.69

Software Package:

Base Linux package will be provided by NXP. Tessolve provides ready to use SDK which can be used on application specific carrier board for end application development.

Operating System:

- Linux v5.4.69 and U-boot v2020.04
- Yocto 3.2 (Gatesgarth)

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Technical Information:

Module Name	S32G2-SMARC-SOM
Processor	• S32G274A
Memory	4GB LPDDR4 @3200 MT/s32GB eMMC / SDIO64MB QSPI
Ethernet	2x 10/100/1000 ports
USB	1x USB 2.0 Host
SerDes subsystem with PCle	 2x supporting Gen3 in X1 and X2 modes
Other Interfaces	4x I2C2x UART2x SPI14x GPIO
Automotive Network	8x CAN2x FlexCAN4x LIN1x FlexLIN1x FlexRay
Operating Voltage Range	3.2 to 5V DC @ 3A
Temperature Range	-40 Deg C to +105 Deg C
Form Factor	82 mm x 50 mm



Ordering Details:

Part Number – SOM	Description
M2A-S32G2-2G32G-IT	2GB RAM/32GB Flash (Temp:-40°C to +85°C)
M2A-S32G2-3G32-IT	3GB RAM/32GB Flash (Temp:-40°C to +85°C)
M2A-S32G2-4G32-IT	4GB RAM/32GB Flash (Temp:-40°C to +85°C)
M2A-S32G2-2G64-AT	2GB RAM/64GB Flash (Temp:-40°C to +105°C)
M2A-S32G2-3G64-AT	3GB RAM/64GB Flash (Temp:-40°C to +105°C)
M2A-S32G2-4GR64-AT	4GB RAM/64GB Flash (Temp:-40°C to +105°C)

Product Brief



NXP S32G2 Application Gateway

Tessolve Semiconductor introduces compact, high-performance application gateway based on S32G274A SMARC SoM targeted for vehicle networking and industrial applications.

Features of Application Gateway:

- Wireless Connectivity: Wi-Fi 6 or 5G/LTE
- M.2 Al Acceleration Module
- M.2 NVMe Storage:
- GNSS module supporting GPS + GLONASS and IMU 6 Axis Sensor
- Automotive Load Dump Protection with 6V to 36V wide supply
- Multiple network interfaces, featuring,
 - 6x CAN/CAN FD, 2x FlexCAN
 - 2x GbE Ports
- 3x USB 2.0 supported through Hub
- Box Dimensions: 190mm x 128mm x 41.75mm, Weight: 1.4 kg



Part Number - EVK	Description
M2A-APBRDS32- EVK-AT	S32G2 EVK (SOM +
	Carrier Board)
	Temp:-40°C to +105°C

Part Number - TGU	Description
M2A-APBRDS32- TGU-AT	Telematics Gateway
	Application Unit
	Temp:-40°C to +105°C

Note: Accessories are available from Tessolve

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Product Brief

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